- Designed for Complementary Use with the BD543 Series
- 70 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- 10 A Peak Collector Current
- Customer-Specified Selections Available

TO-220 PACKAGE (TOP VIEW) 1 2 3

Pin 2 is in electrical contact with the mounting base.

MDTRACA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

| RATING | | | VALUE | UNIT |
|--|--------|------------------|-------------|------|
| | BD544 | | -40 | |
| Collector bose voltage (I | BD544A | ., | -60 | V |
| Collector-base voltage (I _E = 0) | BD544B | V _{CBO} | -80 | V |
| | BD544C | | -100 | |
| | BD544 | | -40 | |
| Collector emitter voltege (I 0) | BD544A | | -60 | V |
| Collector-emitter voltage (I _B = 0) | BD544B | V _{CEO} | -80 | V |
| | BD544C | | -100 | |
| Emitter-base voltage | | V _{EBO} | -5 | V |
| Continuous collector current | | | -8 | Α |
| Peak collector current (see Note 1) | | | -10 | Α |
| Continuous device dissipation at (or below) 25°C case temperature (see Note 2) | | | 70 | W |
| Continuous device dissipation at (or below) 25°C free air temperature (see Note 3) | | | 2 | W |
| Operating free air temperature range | | | -65 to +150 | °C |
| Operating junction temperature range | | | -65 to +150 | °C |
| Storage temperature range | | | -65 to +150 | °C |
| Lead temperature 3.2 mm from case for 10 seconds | | | 260 | °C |

NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%.$

- 2. Derate linearly to 150°C case temperature at the rate of 0.56 W/°C.
- 3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.



BD544, BD544A, BD544B, BD544C PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MARCH 1997

electrical characteristics at 25°C case temperature

| PARAMETER | | TEST CONDITIONS | | | MIN | TYP | MAX | UNIT |
|----------------------|---|---|-------------------------|---------------------|------------|-----|------|------|
| | Collector-emitter | | | BD544 BD544A | -40 -60 | | | |
| V _{(BR)CEO} | breakdown voltage | I _C = -30 mA (see Note 4) | $I_B = 0$ | BD544B | -80 | | | V |
| | | , | | BD544C | -100 | | | |
| | | V _{CE} = -40 V | $V_{BE} = 0$ | BD544 | | | -0.4 | mA |
| I _{CES} | Collector-emitter | $V_{CE} = -60 \text{ V}$ | $V_{BE} = 0$ | BD544A | | | -0.4 | |
| CES | cut-off current | $V_{CE} = -80 \text{ V}$ | $V_{BE} = 0$ | BD544B | | | -0.4 | |
| | | $V_{CE} = -100 \text{ V}$ | $V_{BE} = 0$ | BD544C | | | -0.4 | |
| la-a | Collector cut-off | V _{CE} = -30 V | $I_B = 0$ | BD544/544A | | | -0.7 | mA |
| I _{CEO} | current | $V_{CE} = -60 \text{ V}$ | $I_B = 0$ | BD544B/544C | | | -0.7 | ША |
| I _{EBO} | Emitter cut-off current | V _{EB} = -5 V | I _C = 0 | | | | -1 | mA |
| | Forward current transfer ratio | V _{CE} = -4 V | I _C = -1 A | | 60 | | | |
| h _{FE} | | $V_{CE} = -4 V$ | $I_C = -3 A$ | (see Notes 4 and 5) | 40 | | | |
| | | V _{CE} = -4 V | $I_C = -5 A$ | | 15 | | | |
| | Collector-emitter saturation voltage | I _B = -0.3 A | I _C = -3 A | | | | -0.5 | |
| V _{CE(sat)} | | I _B = -1 A | $I_C = -5 A$ | (see Notes 4 and 5) | | | -0.5 | V |
| | | I _B = -1.6 A | $I_C = -8 A$ | | | | -1 | |
| V _{BE} | Base-emitter voltage | V _{CE} = -4 V | I _C = -5 A | (see Notes 4 and 5) | | | -1.4 | V |
| h _{fe} | Small signal forward current transfer ratio | V _{CE} = -10 V | I _C = -0.5 A | f = 1 kHz | 20 | | | |
| h _{fe} | Small signal forward current transfer ratio | V _{CE} = -10 V | I _C = -0.5 A | f = 1 MHz | 3 | | | |

NOTES: 4. These parameters must be measured using pulse techniques, t_p = 300 μs , duty cycle \leq 2%.

thermal characteristics

| PARAMETER | | MIN | TYP | MAX | UNIT |
|-----------------|---|-----|-----|------|------|
| $R_{\theta JC}$ | Junction to case thermal resistance | | | 1.79 | °C/W |
| $R_{\theta JA}$ | Junction to free air thermal resistance | | | 62.5 | °C/W |

resistive-load-switching characteristics at 25°C case temperature

| PARAMETER TEST CONDITIONS † | | MIN | TYP | MAX | UNIT | | |
|-----------------------------|---------------------------|----------------------|----------------------------------|-----|------|--|----|
| t _{on} Turn-on | time $I_C = -6 \text{ A}$ | $I_{B(on)} = -0.6 A$ | $I_{B(off)} = 0.6 A$ | | 0.4 | | μs |
| t _{off} Turn-off | time $V_{BE(off)} = 4 V$ | $R_L = 5 \Omega$ | t_p = 20 μ s, dc \leq 2% | | 0.7 | | μs |

[†] Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

^{5.} These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN VS COLLECTOR CURRENT 1000 $V_{CE} = -4 \text{ V}$ $T_{C} = 25^{\circ}\text{C}$ $t_{p} = 300 \text{ µs, duty cycle} < 2\%$ 100 10

Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE vs

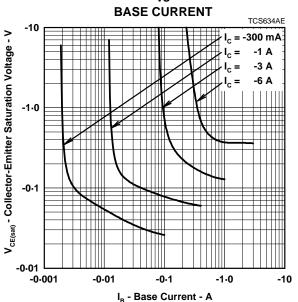
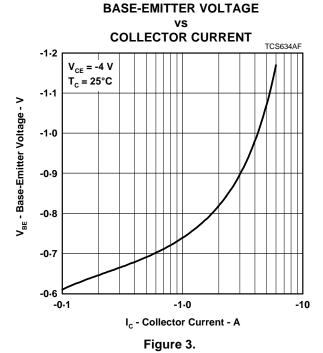


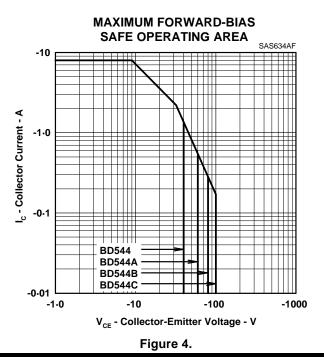
Figure 2.





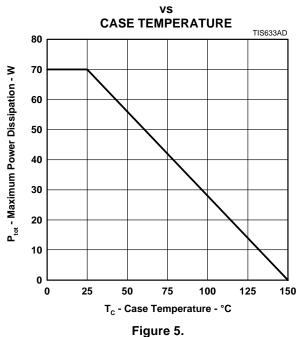


MAXIMUM SAFE OPERATING REGIONS



THERMAL INFORMATION

MAXIMUM POWER DISSIPATION

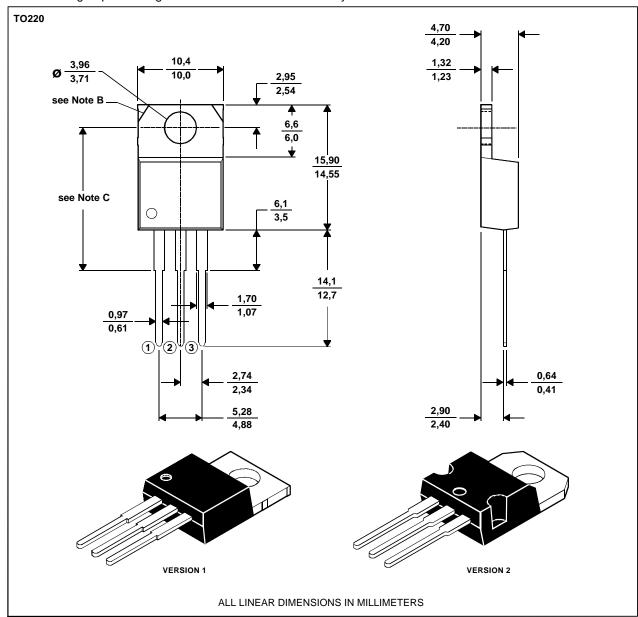


MECHANICAL DATA

TO-220

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTES: A. The centre pin is in electrical contact with the mounting tab.

- B. Mounting tab corner profile according to package version.
- C. Typical fixing hole centre stand off height according to package version. Version 1, 18.0 mm. Version 2, 17.6 mm.

MDXXBE





BD544, BD544A, BD544B, BD544C PNP SILICON POWER TRANSISTORS

JUNE 1973 - REVISED MARCH 1997

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